

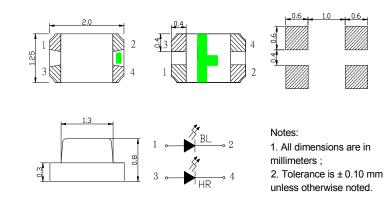
OSRB0805C1E-0.8T

Features

- Bi-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline
 (LxWxT) of 2.0mm x 1.25mm x 0.8mm
- Compatible to IR reflow soldering.

Applications

- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)



•Outline Dimension

Absolute Maximum Rating

Item

DC Forward Current

Reverse Voltage

Power Dissipation

Operating Temperature

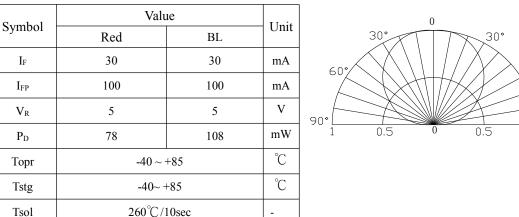
Storage Temperature

Lead Soldering Temperature

Pulse Forward Current*

(Ta=25°C)

Directivity



*Pulse width Max 0.1ms, Duty ratio max 1/10

■Electrical -Optical Characteristics

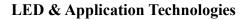
					$V_{\rm F}\left({ m V} ight)$			$I_R(\mu A)$	Iv(mcd)		λD(nm)			201/2(deg)
Part Number	Color			Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.
					I _F =20mA			V _R =5V	I _F =20mA					
OGDD		Red	R		1.8	1.8 2.1 2.6 10 80 150 - 617 625 630 12	120							
OSRB0805C1E-0.8T	Blue	В		2.6	3.1	3.6	10	100	150	-	460	465	470	120

(Ta=25°C)

*1 Tolerance of measurements of dominant wavelength is ±1nm

*2 Tolerance of measurements of luminous intensity is $\pm 15\%$

*3 Tolerance of measurements of forward voltage is ± 0.1 V







ATTENTION OBSERVE PRECAUTIONS ELECTROSTATIC SENSITIVE DEVICES

60°

90°

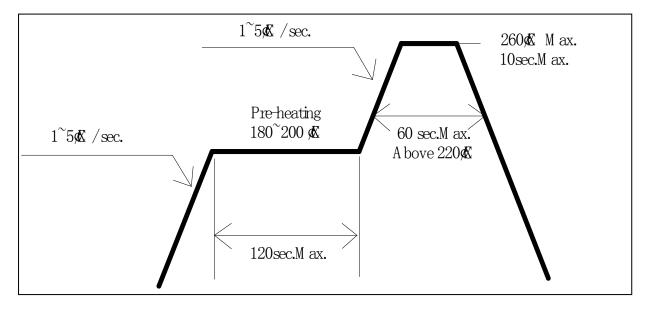


OSRB0805C1E-0.8T

Soldering Conditions

	Reflow Soldering	Han	Hand Soldering				
Pre-Heat	$180 \sim 200^{\circ} \mathrm{C}$						
Pre-Heat Time	120 sec. Max.						
Peak temperature	260°C Max.	Temperature	350°C Max. 3 sec. Max.				
Dipping Time	10 sec. Max.	Soldering time					
Condition	Refer to Temperature-profile		(one time only)				

• Reflow Soldering Condition(Lead-free Solder)



*Recommended soldering conditions vary according to the type of LED

*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.

*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

•All SMD LED products are pb-free soldering available.

• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

• Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

LED & Application Technologies





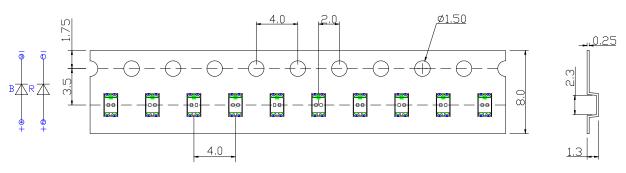




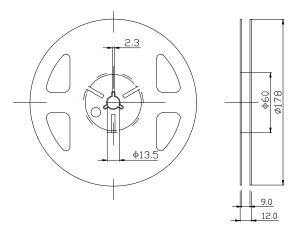
2.0*1.25*0.8mm Red & Blue SMD

OSRB0805C1E-0.8T

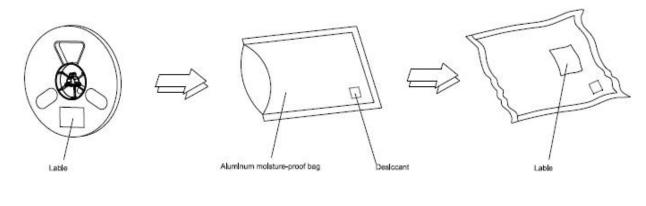
TAPING



Reel Dimensions



Moisture Resistant Packaging



- Notes:
- 1. Unit: mm
- 2. 3000pcs/Reel

LED & Application Technologies





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